TOSHIBA MOS MEMORY PRODUCTS

2048 WORD x 8 BIT EPROM

N CHANNEL SILICON STACKED GATE MOS.

TMM323D TMM323D-1

DESCRIPTION

The TMM323D is a 2048 word x 8 bit ultraviolet erasable and electrically programmable read only memory. For read operation it requires a single 5-volt power supply only. The maximum active power dissipation is 525mW while the maximum standby power dissipation is only 132mW, a 75% savings. Programming can be executed by applying 25-volt and 5-volt at the Vpp and Vcc terminals respectively, and applying a TTL level signal at the other input terminals. Programming the one bit location requires.

only a single pulse, and it is possible to program sequentially, individually or at random. Under the condition Vpp = 25V, read operation is permitted in the program verify mode, and also programming is inhibited by selecting the program inhibit mode.

The TMM323D is fabricated with the N-channel silicon double layer gate MOS technology and is packaged in a standard 24-pin dual-in-line cerdip package

FEATURES

- Single.5-volt power supply
- Access time TMM323D , 450ns (MAX)
 TMM323D-1, 350ns (MAX)

Current 100 mA (active) 25 mA (standby)

- Three state output
- Particular bit location programming

•	Programs	with	one	50ms	pulse
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- Total programming time 100 second
- Inputs and outputs TTL compatible during read and program
- Pin to pin compatible to 2716 type EPROM

PIN CONNECTION

PIN NAMES

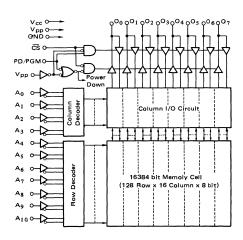
$A_0 - A_{10}$ $O_0 - O_7$	Addresses Outputs
PD/PGM	Chip Select Power down/ Program
V _{CC} , V _{pp} GND	Power Supply Ground

MODE SELECTION

PINS	PD/PGM (18)	CS (20)	Vpp (21)	Vcc (24)	Outputs (9-11, 13-17)
Read	VIL	VIL	5V	5V	D out
Deselect	*	ViH	5V	5V	High Z
Power Down	VIH	*	5V	5V	High Z
Program	W^\II VIH	VIH	25V	5V	D in
Program Verify	VIL.	VIL	25V	5V	D out
Program Inhibit	VIL	VIH	25V	5V	High Z

^{*} VIL or VIH

BLOCK DIAGRAM



MAXIMUM RATINGS

ITEM	SYMBOL	RATING	UNIT
Vcc Supply Voltage with respect to Ground	Vcc	− 0 3 ~ + 7	V
Vpp Supply Voltage with respect to Ground	VPP	-0.3 ~ + 26 5	V
All Input Voltages with respect to Ground	VIN	-03∼+7	V
All Output Voltages with respect to Ground	Vout	-03∼+7	V
Power Dissipation	PD	15	W
Soldering Temperature Times	TSOLDER	260 · 10	°C · sec
Storage Temperature	Tstg	-65 ~ + 125	°C
Operating Temperature	TOPR	0~70	°C

READ OPERATION

D.C. and A.C. OPERATING CONDITIONS

PARAMETER	SYMBOL		MIN.	TYP	MAX	UNIT
D	\/ /1 2\	TMM323D	4 75	5	5 25	V
Power supply	V _{CC} (1, 2)	TMM323D-1	4 5	5	55	V
Power supply	V _{PP} (2)		V _{CC} -06	5	V _{CC} + 0 6	V

D.C. and OPERATING CHARACTERISTICS

 $Ta = 0 \sim 70^{\circ}C$

PARAMETER	SYMBOL	MIN	TYP (3)	MAX	UNIT	CONDITIONS
Input Load Current	ILI		1	±10	μΑ	V _{IN} = 5 25V
Output Leakage Current	ILO			±10	μΑ	Vout = 5 25V/0 45V
Vpp Current (Read)	IPP ₁			5	mΑ	Vpp = 5 85V
Vcc Current (Standby)	lcc ₁		10	25	mA	PD/PGM = VIH, CS = VIL
Vcc Current (Active)	ICC ₂		57	100	mA	PD/PGM = CS = VIL
Input Low Voltage	VIL	-0 1		0 8	V	
Input High Voltage	Vih	20		Vcc + 1	V	
Output Low Voltage	VoL			0 45	V	IoL = 2 1mA
Output High Voltage	Voн	2.4			V	I _{OH} = -400µA

A.C. CHARACTERISTICS

 $Ta = 0 \sim 70^{\circ}C$, $V_{PP} = V_{CC} \pm 0.6V$

PARAMETER	SYMBOL	TMM323D		TMM323D-1		UNIT	CONDITIONS
FANAIVIETEN	STIVIBUL	MIN.	MAX	MIN.	MAX	UNIT	CONDITIONS
Address to Output Delay	tACC1		450		350	ns	PD/PGM = CS = VIL
PD/PGM to Output Delay	t _{ACC2}		450		350	ns	CS = V _{IL}
Chip Select to Output Delay	tco		120		120	ns	PD/PGM = V _{IL}
PD/PGM to Output Float	tpF	0	100	0	100	ns	CS = V _{IL}
Chip Deselect to Output Float	t _{DF}	0	100	0	100	ns	PD/PGM = VIL
Address to Output Hold	t _{OH}	0		0		ns	$PD/PGM = \overline{CS} = V_{IL}$

A.C. Test Conditions

· Output Load ITTL + 100pF

Input Rise and Fall Times (10% ~ 90%) ≤ 20ns

· Input Pulse Levels $V_{IL} = 0.8V, V_{IH} = 2.2V$

Timing Measurement Reference Level Inputs 1V & 2V, Outputs 0 8V & 2V

(Note 4)

CAPACITANCE

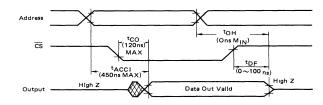
 $Ta = 25^{\circ}C, f = 1MHz$

PARAMETER	CVAADOL	LIMITS			LIMITS		LIMITS		CONDITIONS
	SYMBOL	Min	Тур	Max	UNIT	CONDITIONS			
Input Capacitance	CIN		4	6	pF	VIN = 0V			
Output Capacitance	Соит		8	12	pF	Vout = 0V			

TIMING WAVEFORMS (READ)

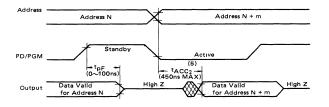
A. Read Mode

PD/PGM = VIL



B. Standby Mode

CS = VIL



Note 1 V_{CC} must be applied simultaneously or before Vpp and cut off simultaneously or after Vpp V_{CC}

- 2 The Vpp terminal is permitted to connect the VCC terminal directly during non-programming
- V_{pp} —

- 3 Typical values are at Ta = 25°C and nominal supply voltages
- 4 This parameter is periodically sampled and is not 100% tested
- 5 The tACC2 is a output data delay time (i.e. access time) from address or PD/PGM whichever changes late

PROGRAM OPERATION

 $Ta = 25^{\circ}C \pm 5^{\circ}C$, $V_{CC} = 5V \pm 5\%$, $V_{PP} = 25V \pm 1V$ (Note 1, 2, 3)

D.C. PROGRAMMING CHARACTERISTICS

PARAMETER	SYMBOL	MIN	TYP.	MAX	UNIT	CONDITIONS
Input Current	ILI			±10	μΑ	VIN = 5 25V/0 45V
Vpp Supply Current	I _{PP1}			5	mA	PD/PGM = VIL
VPP Supply Current During Programming Pulse	IPP ₂			30	mΑ	PD/PGM = V _{IH}
Vcc Supply Current	lcc			100	mA	IOUT = 0 mA
Input Low Level	VIL	-0 1		0.8	V	
Input High Level	ViH	20		Vcc + 1	V	

A.C. PROGRAMMING CHARACTERISTICS

PARAMETER	SYMBOL	MIN	TYP.	MAX	UNIT	CONDITIONS
Address Setup Time	tas	2			μs	
CS Setup Time	tcss	2			μs	
Data Setup Time	t _{DS}	2			μs	
Address Hold Time	tAH	2			μs	
CS Hold Time	tcsH	2			μs	
Data Hold Time	tDH	2			μs	1
Chip Deselect to Output FloatDelay	tDF	0		120	ns	PD/PGM = VIL
Chip Select to Output Delay	tco			120	ns	PD/PGM = VIL
Program Pulse Width	tpw	45	50	55	ms	
Program Pulse Rise Time	tPRT	5			ns	
Program Pulse Fall Time	tPFT	5			ns	

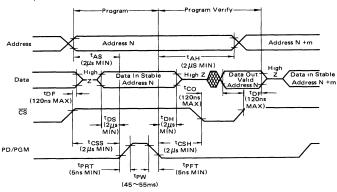
A.C. Test Conditions

- · Input Rise and Fall Times (10% \sim 90%) \leq 20ns
- · Input Pulse Levels VIL = 0 8V, VIH = 2 2V

Timing Measurement Reference Level Input 1V & 2V, Output 0 8V & 2V

TIMING WAVEFORMS (PROGRAM)

 $V_{PP} = 25V \pm 1V, V_{CC} = 5V \pm 5\%$





- 2 Sometimes removing the device from socket and setting the device in socket under the condition Vpp = 25V±1V may destroy its device, so it should be noted during programming
- 3 VPP supply voltage is permitted up to 26V programming, so the voltage over 26V should not be applied to VPP Particularly when switching pulse voltage is applied to VPP, also the over-shoot voltage of its pulse should not be exceeded 26-volt

ERASURE CHARACTERISTICS

The TMM323D's memory cell data can be erased by applying light with wavelengths shorter than 4000, the device is exposed at a distance of 1-cm from the \mathring{A} . ($\mathring{I}\mathring{A} = 10^{-8} \text{ cm}$)

Sunlight and the fluorescent lamps may include 60 minutes 3000 ~ 4000 Å wavelength components

extended periods of time, an opaque seal (Toshiba to about 20 minutes EPROM Protecting Seal AC 901 etc.) will be required (In this case the integrated dose should be 12000 to protect the TMM323D Generally, ultraviolet light $[\mu w/cm^2] \times (20 \times 60)$ [sec] $\cong 15$ [w sec/cm²]) with a wavelength of 2537 Å is recommended for TMM323D-erasing, and in this case the integrated dose (ultraviolet light intensity [w/cm²] x time [sec]) should be over 15 [w sec/cm2]

When Toshiba sterilizing lamp GL-15 is used and lamp surface, erasure should be completed in about

And using a lamp whose ultraviolet light intensity Therefore when used under such lighting for is a 12000 [µw/cm²] will reduce the exposure time

OPERATING INFORMATION

TMM323D-operation-modes are classified into six types, as shown in the following table Each mode can be selected by TTL level signals only. The VCC and Vpp power supplies required are only 5-volt for read operation, and the VPP power supply required is 25-volt during program operation only.

	PINS	PD/PGM	CS	VPP	Vcc	Outputs
MODE		(18)	(20)	(21)	(24)	(9-11, 13-17)
	Read	VIL	VIL	5V	5V	D out
Read Operation	Deselect	*	ViH	5V	5V	High Z
	Power Down	Vih	*	5V	5V	High Z
Program Operation	Program	TUT ∧II	ViH	25V	5V	D in
	Program Verify	VIL	VIL	25V	5V	D out
	Program Inhibit	VIL	VIH	25V	5V	High Z

* VIL or VIH

Read Mode

Assuming that PD/PGM = V_{IL} and \overline{CS} = V_{IL} , the output data is available within tACC1 (MAX.) after stabilizing of the address.

And assuming that PD/PGM = V_{IH} or $\overline{CS} = V_{IH}$, the outputs will become high impedance in state.

When all addresses are in the fixed state and \overline{CS} = VIL, the output data is available within tacca (MAX) after the PD/PGM input is changes to VII from the VIH level (Outputs change to data available state from a high impedance state)

When all addresses are in the fixed state and PD/ PGM = V_{IL}, the output data is available within t_{CO} (MAX) after the $\overline{\text{CS}}$ input is changed to V_{IL} from the VIH level (Outputs change to data available state from a high impedance state.)

Deselect Mode

Assuming that $\overline{CS} = V_{IH}$, the outputs will be in a high impedance state. So two or more TMM323Ds may be tied together on the same data bus. And the CS input of the selected chip must be at the VIL level, and that of the other chip must be at the VIH level

Power Down Mode

Assuming that PD/PGM = V_{1H} , the power dissipation will be reduced to one-fourth of normal active power. (i.e. 525mW \rightarrow 132mW)

Then all outputs will become high impedance in state independent of the $\overline{\text{CS}}$ input level

Program Mode

Initially when received by customers all bits of the TMM323D are in the "1" state which is the erased state

Therefore programming is carried out by electrically writing in the "O" state at the desired bit locations

Programming can be completed by applying the TTL level pulse signal with a pulse width of from 45 to 55 ms to PD/PGM input under the condition where Vpp = 25V and $\overline{\text{CS}}$ = V_{1H}

Programming the TMM323D is permitted in any sequence and also at any particular bit location

But the PD/PGM pulse width applied at one bit location should be over 45ms up to 55ms, and rewriting into the written location is not permitted

When programming is carried out by applying a DC voltage (V_{IH} level) instead of a pulse to the PD/PGM input, erroneous writing may occur sometimes,

so a pulse whose recommended width is 50ms should be used in programming.

Programming the same data to two or more TMM 323Ds simultaneously can be accomplished by connecting the respective pins together

Program Verify Mode

In this mode the VPP power supply is 25V

But assuming that PD/PGM = V_{IL} and \overline{CS} = V_{IL} , it can be possible to read written data

For normal read operation, the VPP power supply voltage required is 5V

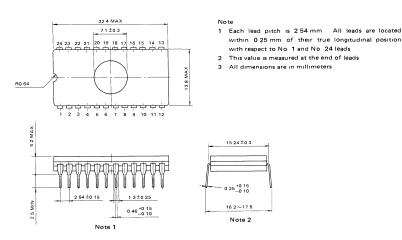
Program Inhibit Mode

Assuming that PD/PGM = V_{IL} and \overline{CS} = V_{IH} under V_{PP} = 25V, it is able to inhibit the programming

According to the above, programming into two or more TMM323Ds mounted on a board will be possible

Programming into a desired chip tied on a common bus line independently is possible by connecting all respective inputs except PD/PGM together and applying a pulse to the PD/PGM input of a desired chip and applying DC voltage at the V_{1L} level to the PD/PGM inputs of the other chip.

OUTLINE DRAWINGS



Note Toshiba does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied, and Toshiba reserves the right, at any time without notice, to change said circuitry

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